



FEATURES

- ✧ Ultra low capacitance: 0.4pF(typical)
- ✧ Up to four I/O lines of protection
- ✧ Low operating voltage: 3.3V
- ✧ Low leakage current: $1\mu\text{A}@V_{\text{RWM}}$
- ✧ Low clamping voltage
- ✧ Protects four data lines
- ✧ Low operating and clamping voltage
- ✧ RoHS compliant

MAIN APPLICATIONS

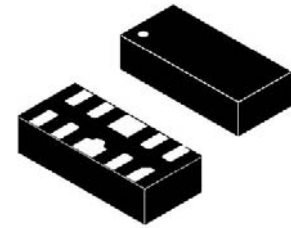
- ✧ Serial ATA
- ✧ PCI express
- ✧ Desktops, servers and notebooks
- ✧ MDDI ports
- ✧ USB2.0, 3.0 and 3.1
- ✧ Display ports
- ✧ HDMI 1.3, 1.4 and 2.0
- ✧ Digital visual interfaces (DVI)

PROTECTION SOLUTION TO MEET

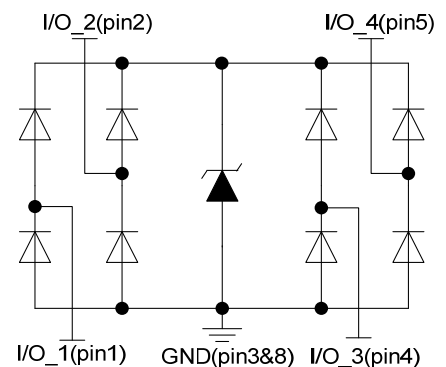
- ✧ IEC61000-4-2 (ESD) $\pm 15\text{kV}$ (air), $\pm 11\text{kV}$ (contact)
- ✧ IEC61000-4-4 (EFT) 40A (5/50ns)
- ✧ IEC61000-4-5 (Lightning) 4A (8/20 μs)

MECHANICAL CHARACTERISTICS

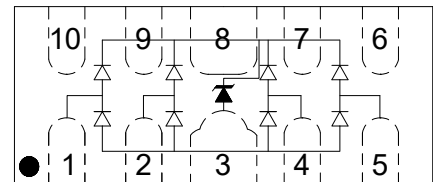
- ✧ DFN2510-10L package
- ✧ Molding compound flammability rating: UL 94V-0
- ✧ Quantity per reel: 3,000pcs
- ✧ Lead finish: lead free
- ✧ Marking code: 3324C



DFN2510-10L



Pin configuration



Top view

ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse power dissipation at 8/20 μs waveform	P_{PP}	40	W
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	+/- 15 +/- 11	kV
Lead soldering temperature	T_L	260(10 sec.)	$^{\circ}\text{C}$
Operating junction temperature range	T_J	-55 to +125	$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-55 to +150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse working voltage	V_{RWM}	I/O to GND			3.3	V
Reverse leakage current	I_R	I/O to GND @ $V_{RWM}=3.3\text{V}$			1	μA
Reverse breakdown voltage	V_{BR}	I/O to GND @ $I_T=1\text{mA}$	4.5			V
Forward voltage	V_F	GND to I/O @ $I_F=10\text{mA}$	0.6	0.9	1.2	V
Clamping voltage (I/O to GND)	V_C	$I_{PP}=4\text{A}$, $t_P=8/20\mu\text{s}$		10.5		V
Junction capacitance	C_J	$V_{RWM}=0\text{V}$, $f=1\text{MHz}$ I/O pin to GND		0.8	0.9	pF
		$V_{RWM}=0\text{V}$, $f=1\text{MHz}$ Between I/O pins		0.4	0.45	pF

RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^{\circ}\text{C}$, unless otherwise noted)

FIG.1: V- I curve characteristics (Uni-directional)

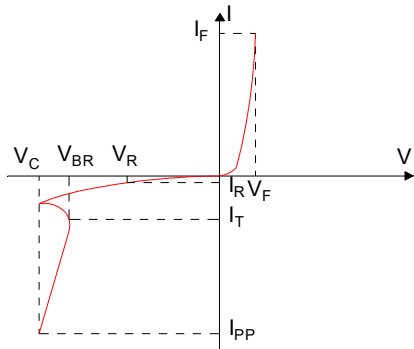


FIG.2: Pulse waveform (8/20 μs)

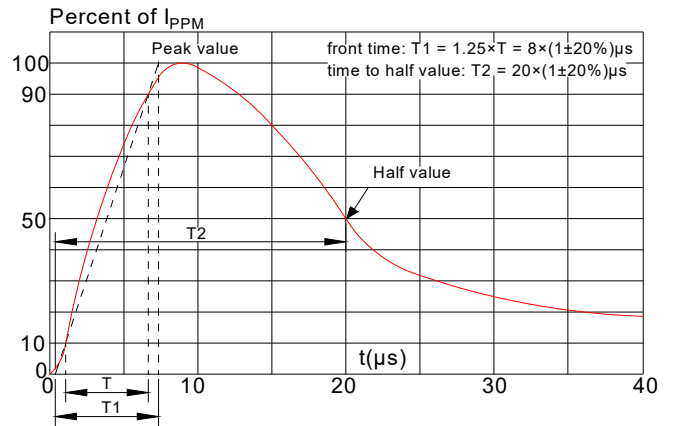


FIG.3: Pulse derating curve

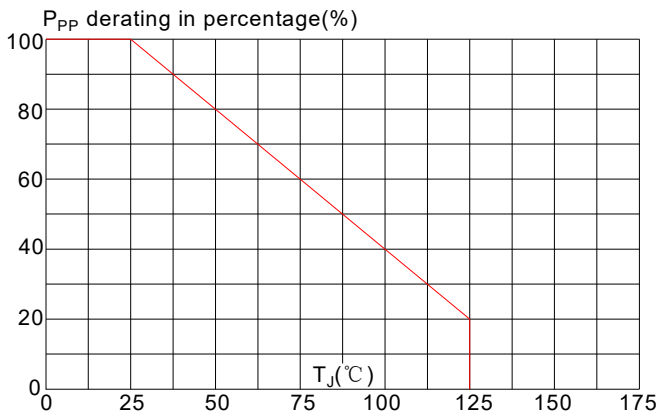
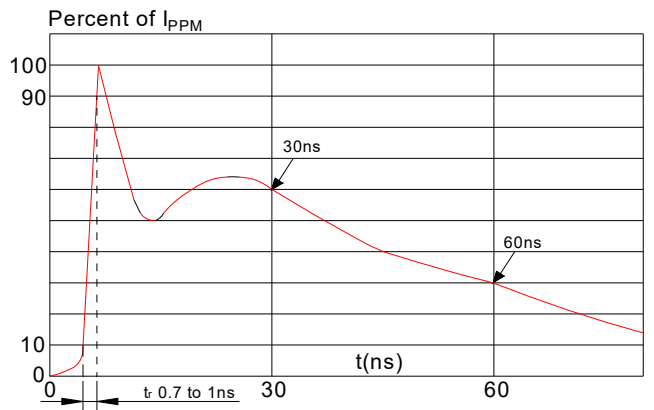
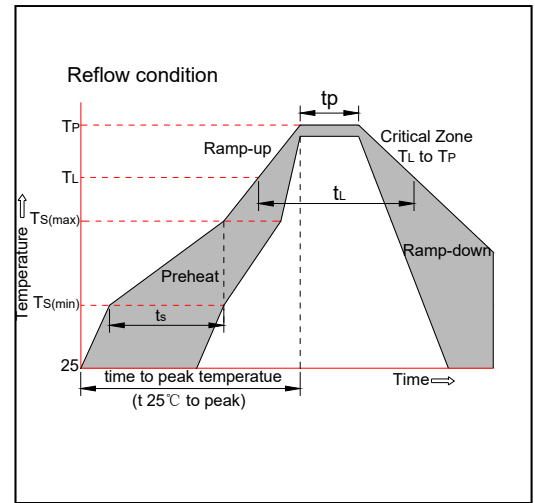


FIG.4: ESD clamping (11KV contact)

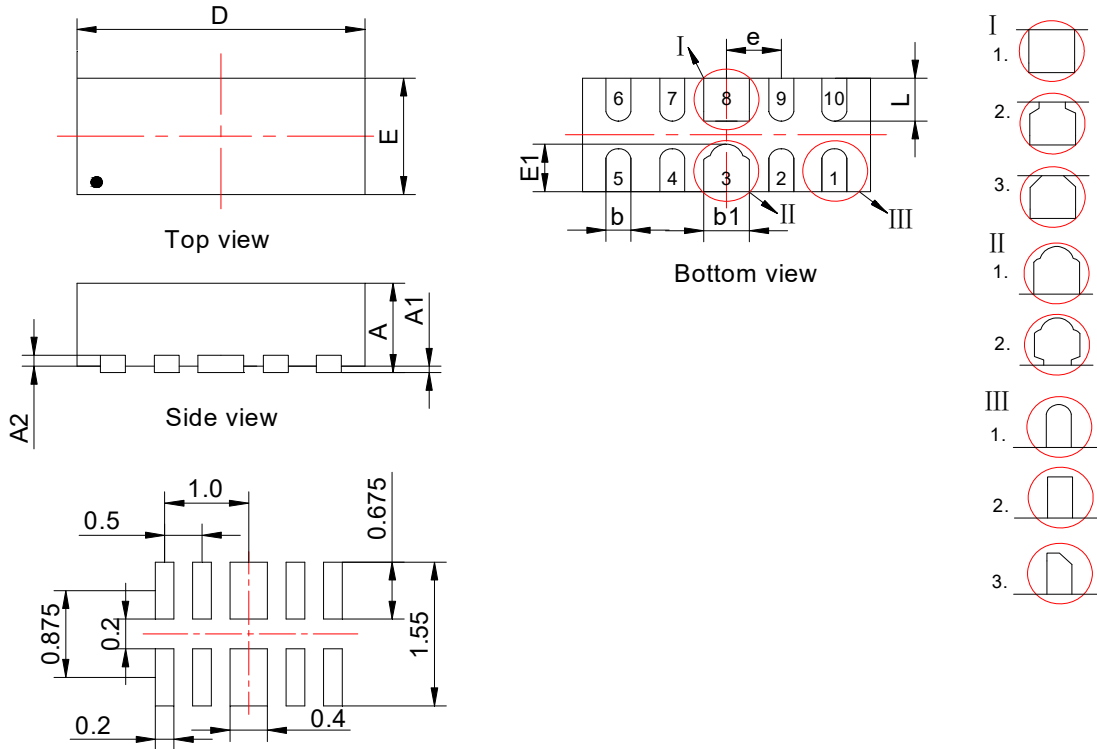


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L)to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C



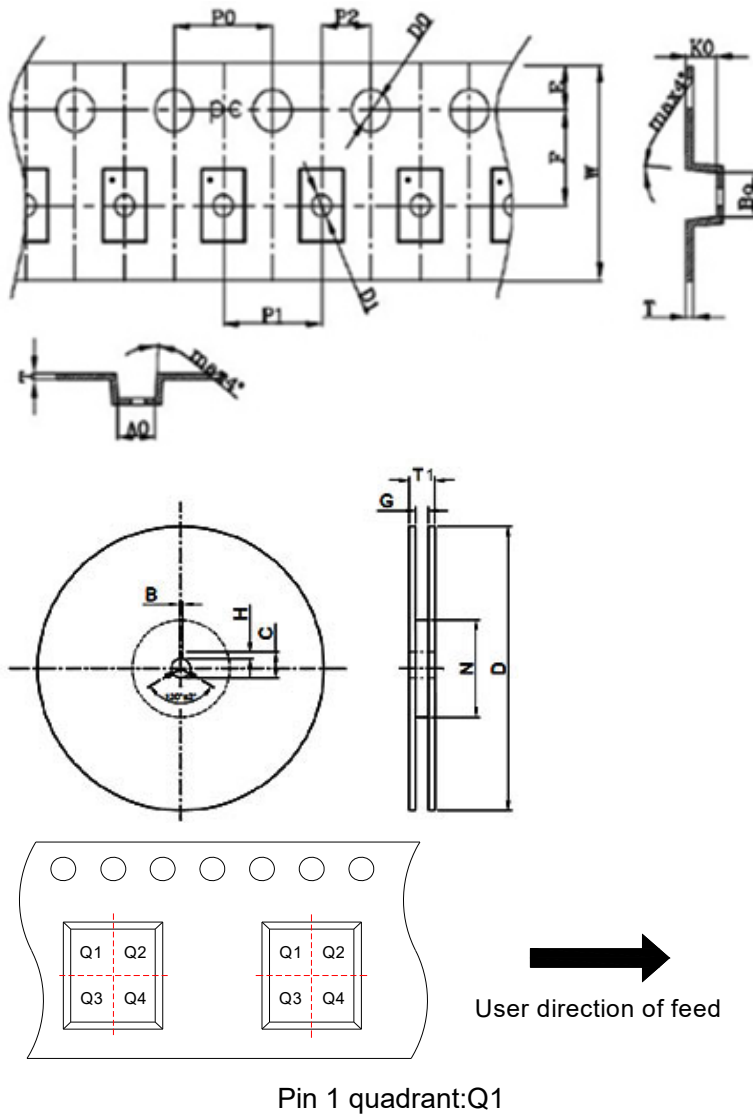
PACKAGE MECHANICAL DATA



Recommended soldering footprint

Symbol	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.46	0.53	0.60	0.018	0.021	0.024
A1	0.00	0.02	0.05	0.000	0.001	0.002
A2	0.15Ref.			0.006Ref.		
b	0.15	0.20	0.25	0.006	0.008	0.010
b1	0.35	0.40	0.45	0.014	0.016	0.018
D	2.40	2.50	2.60	0.094	0.098	0.102
E	0.90	1.00	1.10	0.035	0.039	0.043
E1	0.30	0.40	0.56	0.012	0.016	0.022
e	0.50BSC			0.020BSC		
L	0.30	0.40	0.45	0.012	0.016	0.018

TAPE AND REEL INFORMATION-DFN2510-10L

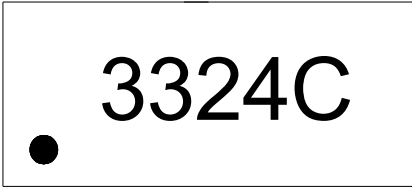


Symbol	Dimensions	
	Millimeters	Inches
	Typ.	Typ.
A0	1.20	0.047
B0	2.75	0.108
K0	0.70	0.028
P0	4.00	0.157
P1	4.00	0.157
P2	2.00	0.079
T	0.20	0.008
E	1.75	0.069
F	3.50	0.138
D0	1.55	0.061
D1	0.60	0.024
W	8.0	0.315
B	2.0	0.079
H	4.0	0.157
C	13.0	0.512
G	8.4	0.331
T1	14.9(max)	0.587(max)
N	60.0	2.362
D	178.0	7.000

ORDERING INFORMATION

PART No.	PACKAGE TYPE	QUANTITY(PCS) REEL	DESCRIPTION
JEU3324C	DFN2510-10L	3,000	7 inch reel pack

MARKING CODE

Part Number	Marking Code
JEU3324C	


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